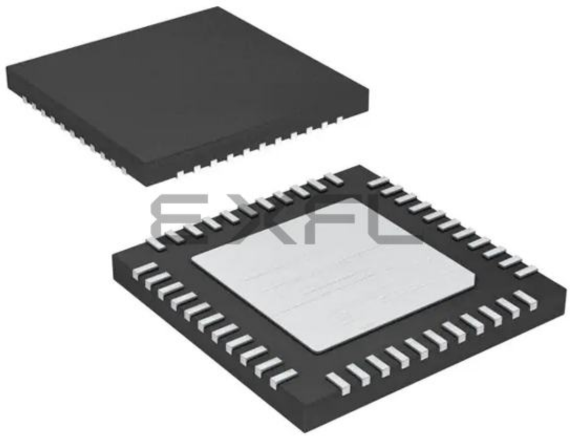

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Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	768 x 8
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Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
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Package / Case	44-VQFN Exposed Pad
Supplier Device Package	44-QFN (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf44k22-i-ml

TABLE 2-3: OSC1 AND OSC2 PIN STATES IN SLEEP MODE

OSC Mode	OSC1 Pin	OSC2 Pin
RC, INTOSC with CLKOUT	Floating, external resistor should pull high	At logic low (clock/4 output)
RC with IO	Floating, external resistor should pull high	Configured as PORTA, bit 6
INTOSC with IO	Configured as PORTA, bit 7	Configured as PORTA, bit 6
EC with IO	Floating, pulled by external clock	Configured as PORTA, bit 6
EC with CLKOUT	Floating, pulled by external clock	At logic low (clock/4 output)
LP, XT, HS	Feedback inverter disabled at quiescent voltage level	Feedback inverter disabled at quiescent voltage level

Note: See Table 4-2 in **Section 4.0 "Reset"** for time-outs due to Sleep and $\overline{\text{MCLR}}$ Reset.

2.11 Clock Switching

The system clock source can be switched between external and internal clock sources via software using the System Clock Select (SCS<1:0>) bits of the OSCCON register.

PIC18(L)F2X/4XK22 devices contain circuitry to prevent clock "glitches" when switching between clock sources. A short pause in the device clock occurs during the clock switch. The length of this pause is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable.

Clock transitions are discussed in greater detail in **Section 3.1.2 "Entering Power-Managed Modes"**.

2.11.1 SYSTEM CLOCK SELECT (SCS<1:0>) BITS

The System Clock Select (SCS<1:0>) bits of the OSCCON register select the system clock source that is used for the CPU and peripherals.

- When SCS<1:0> = `00`, the system clock source is determined by configuration of the FOSC<3:0> bits in the CONFIG1H Configuration register.
- When SCS<1:0> = `10`, the system clock source is chosen by the internal oscillator frequency selected by the INTSRC bit of the OSCTUNE register, the MFIOSEL bit of the OSCCON2 register and the IRCF<2:0> bits of the OSCCON register.
- When SCS<1:0> = `01`, the system clock source is the 32.768 kHz secondary oscillator shared with Timer1, Timer3 and Timer5.

After a Reset, the SCS<1:0> bits of the OSCCON register are always cleared.

Note: Any automatic clock switch, which may occur from Two-Speed Start-up or Fail-Safe Clock Monitor, does not update the SCS<1:0> bits of the OSCCON register. The user can monitor the SOSCRUN, MFIOFS and LFIOFS bits of the OSCCON2 register, and the HFIOFS and OSTS bits of the OSCCON register to determine the current system clock source.

2.11.2 OSCILLATOR START-UP TIME-OUT STATUS (OSTS) BIT

The Oscillator Start-up Time-out Status (OSTS) bit of the OSCCON register indicates whether the system clock is running from the external clock source, as defined by the FOSC<3:0> bits in the CONFIG1H Configuration register, or from the internal clock source. In particular, when the primary oscillator is the source of the primary clock, OSTS indicates that the Oscillator Start-up Timer (OST) has timed out for LP, XT or HS modes.

3.3 Sleep Mode

The Power-Managed Sleep mode in the PIC18(L)F2X/4XK22 devices is identical to the legacy Sleep mode offered in all other PIC microcontroller devices. It is entered by clearing the IDLEN bit of the OSCCON register and executing the SLEEP instruction. This shuts down the selected oscillator (Figure 3-4) and all clock source Status bits are cleared.

Entering the Sleep mode from either Run or Idle mode does not require a clock switch. This is because no clocks are needed once the controller has entered Sleep. If the WDT is selected, the LFINTOSC source will continue to operate. If the SOSC oscillator is enabled, it will also continue to run.

When a wake event occurs in Sleep mode (by interrupt, Reset or WDT time-out), the device will not be clocked until the clock source selected by the SCS<1:0> bits becomes ready (see Figure 3-5), or it will be clocked from the internal oscillator block if either the Two-Speed Start-up or the Fail-Safe Clock Monitor are enabled (see **Section 24.0 "Special Features of the CPU"**). In either case, the OSTS bit is set when the primary clock is providing the device clocks. The IDLEN and SCS bits are not affected by the wake-up.

3.4 Idle Modes

The Idle modes allow the controller's CPU to be selectively shut down while the peripherals continue to operate. Selecting a particular Idle mode allows users to further manage power consumption.

If the IDLEN bit is set to a '1' when a SLEEP instruction is executed, the peripherals will be clocked from the clock source selected by the SCS<1:0> bits; however, the CPU will not be clocked. The clock source status bits are not affected. Setting IDLEN and executing a SLEEP instruction provides a quick method of switching from a given Run mode to its corresponding Idle mode.

If the WDT is selected, the LFINTOSC source will continue to operate. If the SOSC oscillator is enabled, it will also continue to run.

Since the CPU is not executing instructions, the only exits from any of the Idle modes are by interrupt, WDT time-out, or a Reset. When a wake event occurs, CPU execution is delayed by an interval of T_{CSD} while it becomes ready to execute code. When the CPU begins executing code, it resumes with the same clock source for the current Idle mode. For example, when waking from RC_IDLE mode, the internal oscillator block will clock the CPU and peripherals (in other words, RC_RUN mode). The IDLEN and SCS bits are not affected by the wake-up.

While in any Idle mode or the Sleep mode, a WDT time-out will result in a WDT wake-up to the Run mode currently specified by the SCS<1:0> bits.

FIGURE 3-4: TRANSITION TIMING FOR ENTRY TO SLEEP MODE

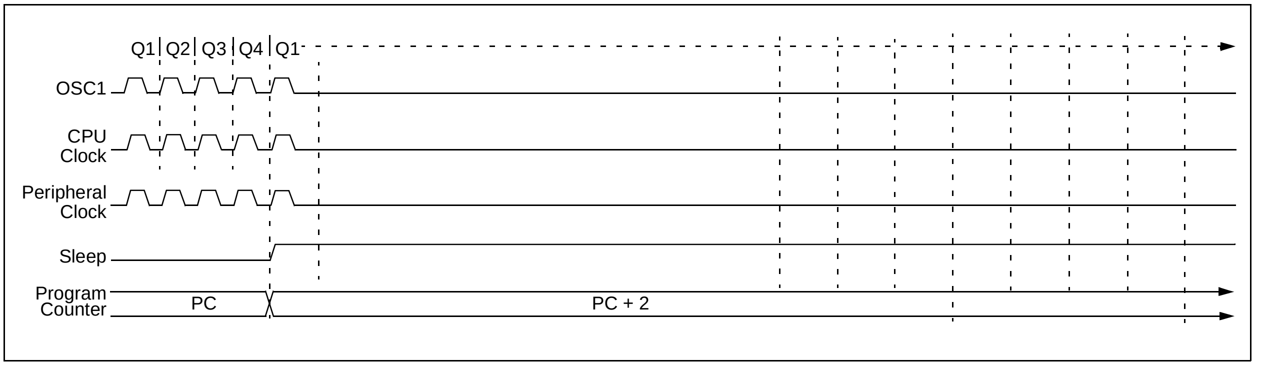


TABLE 5-1: SPECIAL FUNCTION REGISTER MAP FOR PIC18(L)F2X/4XK22 DEVICES

Address	Name	Address	Name	Address	Name	Address	Name	Address	Name
FFFh	TOSU	FD7h	TMR0H	FAFh	SPBRG1	F87h	—(2)	F5Fh	CCPR3H
FFEh	TOSH	FD6h	TMR0L	FAEh	RCREG1	F86h	—(2)	F5Eh	CCPR3L
FFDh	TOSL	FD5h	T0CON	FADh	TXREG1	F85h	—(2)	F5Dh	CCP3CON
FFCh	STKPTR	FD4h	—(2)	FACh	TXSTA1	F84h	PORTE	F5Ch	PWM3CON
FFBh	PCLATU	FD3h	OSCCON	FABh	RCSTA1	F83h	PORTD(3)	F5Bh	ECCP3AS
FFAh	PCLATH	FD2h	OSCCON2	FAAh	EEADRH(4)	F82h	PORTC	F5Ah	PSTR3CON
FF9h	PCL	FD1h	WDTCON	FA9h	EEADR	F81h	PORTB	F59h	CCPR4H
FF8h	TBLPTRU	FD0h	RCON	FA8h	EEDATA	F80h	PORTA	F58h	CCPR4L
FF7h	TBLPTRH	FCFh	TMR1H	FA7h	EECON2(1)	F7Fh	IPR5	F57h	CCP4CON
FF6h	TBLPTRL	FCEh	TMR1L	FA6h	EECON1	F7Eh	PIR5	F56h	CCPR5H
FF5h	TABLAT	FCDh	T1CON	FA5h	IPR3	F7Dh	PIE5	F55h	CCPR5L
FF4h	PRODH	FCCh	T1GCON	FA4h	PIR3	F7Ch	IPR4	F54h	CCP5CON
FF3h	PRODL	FCBh	SSP1CON3	FA3h	PIE3	F7Bh	PIR4	F53h	TMR4
FF2h	INTCON	FCAh	SSP1MSK	FA2h	IPR2	F7Ah	PIE4	F52h	PR4
FF1h	INTCON2	FC9h	SSP1BUF	FA1h	PIR2	F79h	CM1CON0	F51h	T4CON
FF0h	INTCON3	FC8h	SSP1ADD	FA0h	PIE2	F78h	CM2CON0	F50h	TMR5H
FEFh	INDF0(1)	FC7h	SSP1STAT	F9Fh	IPR1	F77h	CM2CON1	F4Fh	TMR5L
FEEh	POSTINC0(1)	FC6h	SSP1CON1	F9Eh	PIR1	F76h	SPBRGH2	F4Eh	T5CON
FEDh	POSTDEC0(1)	FC5h	SSP1CON2	F9Dh	PIE1	F75h	SPBRG2	F4Dh	T5GCON
FECh	PREINC0(1)	FC4h	ADRESH	F9Ch	HLVDCON	F74h	RCREG2	F4Ch	TMR6
FEBh	PLUSW0(1)	FC3h	ADRESL	F9Bh	OSCTUNE	F73h	TXREG2	F4Bh	PR6
FEAh	FSR0H	FC2h	ADCON0	F9Ah	—(2)	F72h	TXSTA2	F4Ah	T6CON
FE9h	FSR0L	FC1h	ADCON1	F99h	—(2)	F71h	RCSTA2	F49h	CCPTMRS0
FE8h	WREG	FC0h	ADCON2	F98h	—(2)	F70h	BAUDCON2	F48h	CCPTMRS1
FE7h	INDF1(1)	FBFh	CCPR1H	F97h	—(2)	F6Fh	SSP2BUF	F47h	SRCON0
FE6h	POSTINC1(1)	FBEh	CCPR1L	F96h	TRISE	F6Eh	SSP2ADD	F46h	SRCON1
FE5h	POSTDEC1(1)	FBDh	CCP1CON	F95h	TRISD(3)	F6Dh	SSP2STAT	F45h	CTMUCONH
FE4h	PREINC1(1)	FBCh	TMR2	F94h	TRISC	F6Ch	SSP2CON1	F44h	CTMUCONL
FE3h	PLUSW1(1)	FBBh	PR2	F93h	TRISB	F6Bh	SSP2CON2	F43h	CTMUICON
FE2h	FSR1H	FBAh	T2CON	F92h	TRISA	F6Ah	SSP2MSK	F42h	VREFCON0
FE1h	FSR1L	FB9h	PSTR1CON	F91h	—(2)	F69h	SSP2CON3	F41h	VREFCON1
FE0h	BSR	FB8h	BAUDCON1	F90h	—(2)	F68h	CCPR2H	F40h	VREFCON2
FDFh	INDF2(1)	FB7h	PWM1CON	F8Fh	—(2)	F67h	CCPR2L	F3Fh	PMD0
FDEh	POSTINC2(1)	FB6h	ECCP1AS	F8Eh	—(2)	F66h	CCP2CON	F3Eh	PMD1
FDDh	POSTDEC2(1)	FB5h	—(2)	F8Dh	LATE(3)	F65h	PWM2CON	F3Dh	PMD2
FDCh	PREINC2(1)	FB4h	T3GCON	F8Ch	LATD(3)	F64h	ECCP2AS	F3Ch	ANSELE
FDBh	PLUSW2(1)	FB3h	TMR3H	F8Bh	LATC	F63h	PSTR2CON	F3Bh	ANSELD
FDAh	FSR2H	FB2h	TMR3L	F8Ah	LATB	F62h	IOCB	F3Ah	ANSELC
FD9h	FSR2L	FB1h	T3CON	F89h	LATA	F61h	WPUB	F39h	ANSELB
FD8h	STATUS	FB0h	SPBRGH1	F88h	—(2)	F60h	SLRCON	F38h	ANSELA

Note 1: This is not a physical register.
2: Unimplemented registers are read as ‘0’.
3: PIC18(L)F4XK22 devices only.
4: PIC18(L)F26K22 and PIC18(L)F46K22 devices only.

REGISTER 9-4: PIR1: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 1

U-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
—	ADIF	RC1IF	TX1IF	SSP1IF	CCP1IF	TMR2IF	TMR1IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as ‘0’.

bit 6 **ADIF:** A/D Converter Interrupt Flag bit
1 = An A/D conversion completed (must be cleared by software)
0 = The A/D conversion is not complete or has not been started

bit 5 **RC1IF:** EUSART1 Receive Interrupt Flag bit
1 = The EUSART1 receive buffer, RCREG1, is full (cleared when RCREG1 is read)
0 = The EUSART1 receive buffer is empty

bit 4 **TX1IF:** EUSART1 Transmit Interrupt Flag bit
1 = The EUSART1 transmit buffer, TXREG1, is empty (cleared when TXREG1 is written)
0 = The EUSART1 transmit buffer is full

bit 3 **SSP1IF:** Master Synchronous Serial Port 1 Interrupt Flag bit
1 = The transmission/reception is complete (must be cleared by software)
0 = Waiting to transmit/receive

bit 2 **CCP1IF:** CCP1 Interrupt Flag bit
Capture mode:
1 = A TMR register capture occurred (must be cleared by software)
0 = No TMR register capture occurred
Compare mode:
1 = A TMR register compare match occurred (must be cleared by software)
0 = No TMR register compare match occurred
PWM mode:
Unused in this mode

bit 1 **TMR2IF:** TMR2 to PR2 Match Interrupt Flag bit
1 = TMR2 to PR2 match occurred (must be cleared by software)
0 = No TMR2 to PR2 match occurred

bit 0 **TMR1IF:** TMR1 Overflow Interrupt Flag bit
1 = TMR1 register overflowed (must be cleared by software)
0 = TMR1 register did not overflow

Note 1: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Interrupt Enable bit, GIE/GIEH of the INTCON register.

Note: User software should ensure the appropriate interrupt flag bits are cleared prior to enabling an interrupt and after servicing that interrupt.

13.6 Register Definitions: Timer2/4/6 Control

REGISTER 13-1: TxCON: TIMER2/TIMER4/TIMER6 CONTROL REGISTER

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	TxOUTPS<3:0>				TMRxON	TxCKPS<1:0>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **Unimplemented:** Read as ‘0’

bit 6-3 **TxOUTPS<3:0>:** TimerX Output Postscaler Select bits
0000 = 1:1 Postscaler
0001 = 1:2 Postscaler
0010 = 1:3 Postscaler
0011 = 1:4 Postscaler
0100 = 1:5 Postscaler
0101 = 1:6 Postscaler
0110 = 1:7 Postscaler
0111 = 1:8 Postscaler
1000 = 1:9 Postscaler
1001 = 1:10 Postscaler
1010 = 1:11 Postscaler
1011 = 1:12 Postscaler
1100 = 1:13 Postscaler
1101 = 1:14 Postscaler
1110 = 1:15 Postscaler
1111 = 1:16 Postscaler

bit 2 **TMRxON:** TimerX On bit
1 = TimerX is on
0 = TimerX is off

bit 1-0 **TxCKPS<1:0>:** Timer2-type Clock Prescale Select bits
00 = Prescaler is 1
01 = Prescaler is 4
1x = Prescaler is 16

14.1.4 CCP PRESCALER

There are four prescaler settings specified by the CCPxM<3:0> bits of the CCPxCON register. Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. Any Reset will clear the prescaler counter.

Switching from one capture prescaler to another does not clear the prescaler and may generate a false interrupt. To avoid this unexpected operation, turn the module off by clearing the CCPxCON register before changing the prescaler. Example 14-1 demonstrates the code to perform this function.

EXAMPLE 14-1: CHANGING BETWEEN CAPTURE PRESCALERS

```
#define NEW_CAPT_PS 0x06    //Capture
                            // Prescale 4th
...                         // rising edge
CCPxCON = 0;                // Turn the CCP
                            // Module Off
CCPxCON = NEW_CAPT_PS;      // Turn CCP module
                            // on with new
                            // prescale value
```

14.1.5 CAPTURE DURING SLEEP

Capture mode requires a 16-bit TimerX module for use as a time base. There are four options for driving the 16-bit TimerX module in Capture mode. It can be driven by the system clock (FOSC), the instruction clock (FOSC/4), or by the external clock sources, the Secondary Oscillator (SOSC), or the TxCKI clock input. When the 16-bit TimerX resource is clocked by FOSC or FOSC/4, TimerX will not increment during Sleep. When the device wakes from Sleep, TimerX will continue from its previous state. Capture mode will operate during Sleep when the 16-bit TimerX resource is clocked by one of the external clock sources (SOSC or the TxCKI pin).

TABLE 14-3: REGISTERS ASSOCIATED WITH CAPTURE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
CCP1CON	P1M<1:0>		DC1B<1:0>		CCP1M<3:0>				198
CCP2CON	P2M<1:0>		DC2B<1:0>		CCP2M<3:0>				198
CCP3CON	P3M<1:0>		DC3B<1:0>		CCP3M<3:0>				198
CCP4CON	—	—	DC4B<1:0>		CCP4M<3:0>				198
CCP5CON	—	—	DC5B<1:0>		CCP5M<3:0>				198
CCPR1H	Capture/Compare/PWM Register 1 High Byte (MSB)								—
CCPR1L	Capture/Compare/PWM Register 1 Low Byte (LSB)								—
CCPR2H	Capture/Compare/PWM Register 2 High Byte (MSB)								—
CCPR2L	Capture/Compare/PWM Register 2 Low Byte (LSB)								—
CCPR3H	Capture/Compare/PWM Register 3 High Byte (MSB)								—
CCPR3L	Capture/Compare/PWM Register 3 Low Byte (LSB)								—
CCPR4H	Capture/Compare/PWM Register 4 High Byte (MSB)								—
CCPR4L	Capture/Compare/PWM Register 4 Low Byte (LSB)								—
CCPR5H	Capture/Compare/PWM Register 5 High Byte (MSB)								—
CCPR5L	Capture/Compare/PWM Register 5 Low Byte (LSB)								—
CCPTMRS0	C3TSEL<1:0>		—	C2TSEL<1:0>		—	C1TSEL<1:0>		201
CCPTMRS1	—	—	—	—	C5TSEL<1:0>		C4TSEL<1:0>		201
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	109
IPR1	—	ADIP	RC1IP	TX1IP	SSP1IP	CCP1IP	TMR2IP	TMR1IP	121
IPR2	OSCFIP	C1IP	C2IP	EEIP	BCL1IP	HLVDIP	TMR3IP	CCP2IP	122
IPR4	—	—	—	—	—	CCP5IP	CCP4IP	CCP3IP	124
PIE1	—	ADIE	RC1IE	TX1IE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	117

Legend: — = Unimplemented location, read as '0'. Shaded bits are not used by Capture mode.

Note 1: These registers/bits are available on PIC18(L)F4XK22 devices.

15.2.3 SPI MASTER MODE

The master can initiate the data transfer at any time because it controls the SCKx line. The master determines when the slave (Processor 2, Figure 15-5) is to broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPxBUF register is written to. If the SPI is only going to receive, the SDOx output could be disabled (programmed as an input). The SSPxSR register will continue to shift in the signal present on the SDIx pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPxBUF register as if a normal received byte (interrupts and Status bits appropriately set).

The clock polarity is selected by appropriately programming the CKP bit of the SSPxCON1 register and the CKE bit of the SSPxSTAT register.

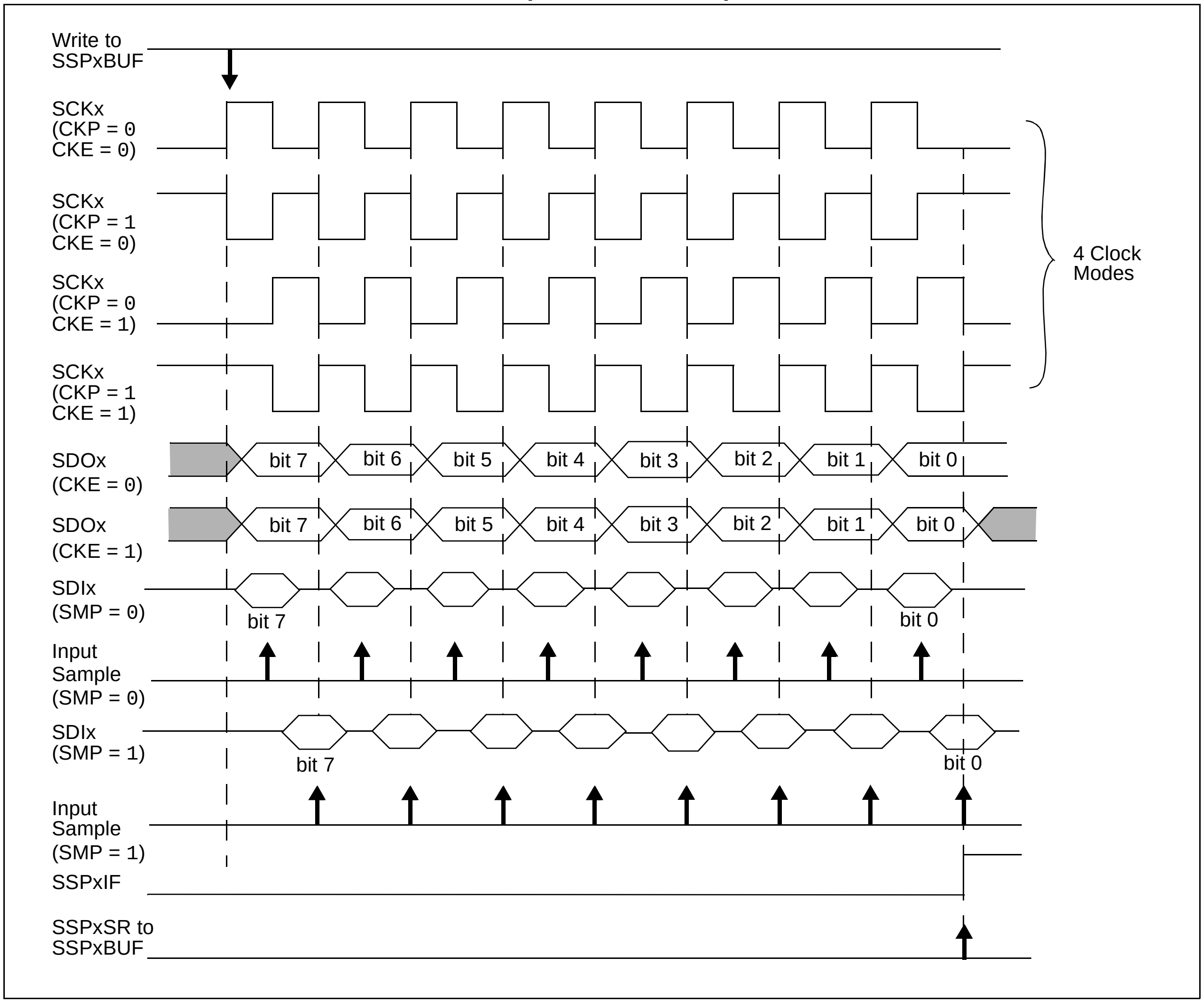
This then, would give waveforms for SPI communication as shown in Figure 15-6, Figure 15-8, Figure 15-9 and Figure 15-10, where the MSB is transmitted first. In Master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- FOSC/4 (or TCY)
- FOSC/16 (or 4 * TCY)
- FOSC/64 (or 16 * TCY)
- Timer2 output/2
- FOSC/(4 * (SSPxADD + 1))

Figure 15-6 shows the waveforms for Master mode.

When the CKE bit is set, the SDOx data is valid before there is a clock edge on SCKx. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPxBUF is loaded with the received data is shown.

FIGURE 15-6: SPI MODE WAVEFORM (MASTER MODE)



15.5.2 SLAVE RECEPTION

When the $R/\overline{W}$ bit of a matching received address byte is clear, the $R/\overline{W}$ bit of the SSPxSTAT register is cleared. The received address is loaded into the SSPxBUF register and acknowledged.

When the overflow condition exists for a received address, then not Acknowledge is given. An overflow condition is defined as either bit BF of the SSPxSTAT register is set, or bit SSPxOV of the SSPxCON1 register is set. The BOEN bit of the SSPxCON3 register modifies this operation. For more information see Register 15-5.

An MSSPx interrupt is generated for each transferred data byte. Flag bit, SSPxIF, must be cleared by software.

When the SEN bit of the SSPxCON2 register is set, SCLx will be held low (clock stretch) following each received byte. The clock must be released by setting the CKP bit of the SSPxCON1 register, except sometimes in 10-bit mode. See **Section 15.2.3 “SPI Master Mode”** for more detail.

15.5.2.1 7-bit Addressing Reception

This section describes a standard sequence of events for the MSSPx module configured as an I^2C slave in 7-bit Addressing mode. All decisions made by hardware or software and their effect on reception. Figure 15-14 and Figure 15-5 are used as a visual reference for this description.

This is a step by step process of what typically must be done to accomplish I^2C communication.

1. Start bit detected.
2. S bit of SSPxSTAT is set; SSPxIF is set if interrupt on Start detect is enabled.
3. Matching address with $R/\overline{W}$ bit clear is received.
4. The slave pulls SDAx low sending an $\overline{ACK}$ to the master, and sets SSPxIF bit.
5. Software clears the SSPxIF bit.
6. Software reads received address from SSPxBUF clearing the BF flag.
7. If SEN = 1; Slave software sets CKP bit to release the SCLx line.
8. The master clocks out a data byte.
9. Slave drives SDAx low sending an $\overline{ACK}$ to the master, and sets SSPxIF bit.
10. Software clears SSPxIF.
11. Software reads the received byte from SSPxBUF clearing BF.
12. Steps 8-12 are repeated for all received bytes from the master.
13. Master sends Stop condition, setting P bit of SSPxSTAT, and the bus goes Idle.

15.5.2.2 7-bit Reception with AHEN and DHEN

Slave device reception with AHEN and DHEN set operate the same as without these options with extra interrupts and clock stretching added after the 8th falling edge of SCLx. These additional interrupts allow the slave software to decide whether it wants to $\overline{ACK}$ the receive address or data byte, rather than the hardware. This functionality adds support for PMBus™ that was not present on previous versions of this module.

This list describes the steps that need to be taken by slave software to use these options for I^2C communication. Figure 15-16 displays a module using both address and data holding. Figure 15-17 includes the operation with the SEN bit of the SSPxCON2 register set.

1. S bit of SSPxSTAT is set; SSPxIF is set if interrupt on Start detect is enabled.
2. Matching address with $R/\overline{W}$ bit clear is clocked in. SSPxIF is set and CKP cleared after the 8th falling edge of SCLx.
3. Slave clears the SSPxIF.
4. Slave can look at the ACKTIM bit of the SSPxCON3 register to determine if the SSPxIF was after or before the $\overline{ACK}$.
5. Slave reads the address value from SSPxBUF, clearing the BF flag.
6. Slave sets $\overline{ACK}$ value clocked out to the master by setting ACKDT.
7. Slave releases the clock by setting CKP.
8. SSPxIF is set after an $\overline{ACK}$, not after a NACK.
9. If SEN = 1 the slave hardware will stretch the clock after the $\overline{ACK}$.
10. Slave clears SSPxIF

.

Note:	SSPxIF is still set after the 9th falling edge of SCLx even if there is no clock stretching and BF has been cleared. Only if NACK is sent to master is SSPxIF not set.

11. SSPxIF set and CKP cleared after 8th falling edge of SCLx for a received data byte.
12. Slave looks at ACKTIM bit of SSPxCON3 to determine the source of the interrupt.
13. Slave reads the received data from SSPxBUF clearing BF.
14. Steps 7-14 are the same for each received data byte.
15. Communication is ended by either the slave sending an $\overline{ACK}$ = 1, or the master sending a Stop condition. If a Stop is sent and Interrupt on Stop detect is disabled, the slave will only know by polling the P bit of the SSTSTAT register.

17.2.2 COMPLETION OF A CONVERSION

When the conversion is complete, the ADC module will:

- Clear the GO/$\overline{\text{DONE}}$ bit
- Set the ADIF flag bit
- Update the ADRESH:ADRESL registers with new conversion result

17.2.3 DISCHARGE

The discharge phase is used to initialize the value of the capacitor array. The array is discharged after every sample. This feature helps to optimize the unity-gain amplifier, as the circuit always needs to charge the capacitor array, rather than charge/discharge based on previous measure values.

17.2.4 TERMINATING A CONVERSION

If a conversion must be terminated before completion, the GO/$\overline{\text{DONE}}$ bit can be cleared by software. The ADRESH:ADRESL registers will not be updated with the partially complete Analog-to-Digital conversion sample. Instead, the ADRESH:ADRESL register pair will retain the value of the previous conversion.

Note:	A device Reset forces all registers to their Reset state. Thus, the ADC module is turned off and any pending conversion is terminated.

17.2.5 DELAY BETWEEN CONVERSIONS

After the A/D conversion is completed or aborted, a 2 T_{AD} wait is required before the next acquisition can be started. After this wait, the currently selected channel is reconnected to the charge holding capacitor commencing the next acquisition.

17.2.6 ADC OPERATION IN POWER-MANAGED MODES

The selection of the automatic acquisition time and A/D conversion clock is determined in part by the clock source and frequency while in a power-managed mode.

If the A/D is expected to operate while the device is in a power-managed mode, the ACQT<2:0> and ADCS<2:0> bits in ADCON2 should be updated in accordance with the clock source to be used in that mode. After entering the mode, an A/D acquisition or conversion may be started. Once started, the device should continue to be clocked by the same clock source until the conversion has been completed.

If desired, the device may be placed into the corresponding Idle mode during the conversion. If the device clock frequency is less than 1 MHz, the A/D F_{RC} clock source should be selected.

17.2.7 ADC OPERATION DURING SLEEP

The ADC module can operate during Sleep. This requires the ADC clock source to be set to the F_{RC} option. When the F_{RC} clock source is selected, the ADC waits one additional instruction before starting the conversion. This allows the `SLEEP` instruction to be executed, which can reduce system noise during the conversion. If the ADC interrupt is enabled, the device will wake-up from Sleep when the conversion completes. If the ADC interrupt is disabled, the ADC module is turned off after the conversion completes, although the ADON bit remains set.

When the ADC clock source is something other than F_{RC}, a `SLEEP` instruction causes the present conversion to be aborted and the ADC module is turned off, although the ADON bit remains set.

17.2.8 SPECIAL EVENT TRIGGER

Two Special Event Triggers are available to start an A/D conversion: CTMU and CCP5. The Special Event Trigger source is selected using the TRIGSEL bit in ADCON1.

When TRIGSEL = `0`, the CCP5 module is selected as the Special Event Trigger source. To enable the Special Event Trigger in the CCP module, set CCP5M<3:0> = `1011`, in the CCP5CON register.

When TRIGSEL = `1`, the CTMU module is selected. The CTMU module requires that the CTTRIG bit in CTMUCONH is set to enable the Special Event Trigger.

In addition to TRIGSEL bit, the following steps are required to start an A/D conversion:

- The A/D module must be enabled (ADON = `1`)
- The appropriate analog input channel selected
- The minimum acquisition period set one of these ways:
  - Timing provided by the user
  - Selection made of an appropriate T_{ACQ} time

With these conditions met, the trigger sets the GO/$\overline{\text{DONE}}$ bit and the A/D acquisition starts.

If the A/D module is not enabled (ADON = `0`), the module ignores the Special Event Trigger.

17.2.9 PERIPHERAL MODULE DISABLE

When a peripheral module is not used or inactive, the module can be disabled by setting the Module Disable bit in the PMD registers. This will reduce power consumption to an absolute minimum. Setting the PMD bits holds the module in Reset and disconnects the module's clock source. The Module Disable bit for the ADC module is ADCMD in the PMD2 Register. See **Section 3.0 "Power-Managed Modes"** for more information.

EXAMPLE 19-2: CURRENT CALIBRATION ROUTINE

```
#include "p18cxxx.h"

#define COUNT 500                           //@ 8MHz = 125uS.
#define DELAY for(i=0;i<COUNT;i++)
#define RCAL .027                           //R value is 4200000 (4.2M)
                                            //scaled so that result is in
                                            //1/100th of uA
#define ADSCALE 1023                        //for unsigned conversion 10 sig bits
#define ADREF 3.3                           //Vdd connected to A/D Vr+

int main(void)
{
    int i;
    int j = 0;                              //index for loop
    unsigned int Vread = 0;
    double VTot = 0;
    float Vavg=0, Vcal=0, CTMUISrc = 0;     //float values stored for calcs

//assume CTMU and A/D have been set up correctly
//see Example 25-1 for CTMU & A/D setup
setup();

CTMUCONHbits.CTMUEN = 1;                    //Enable the CTMU
CTMUCONLbits.EDG1STAT = 0;                  // Set Edge status bits to zero
CTMUCONLbits.EDG2STAT = 0;
    for(j=0;j<10;j++)
    {
        CTMUCONHbits.IDISSEN = 1;           //drain charge on the circuit
        DELAY;                              //wait 125us
        CTMUCONHbits.IDISSEN = 0;           //end drain of circuit

        CTMUCONLbits.EDG1STAT = 1;          //Begin charging the circuit
                                            //using CTMU current source
        DELAY;                              //wait for 125us
        CTMUCONLbits.EDG1STAT = 0;          //Stop charging circuit

        PIR1bits.ADIF = 0;                  //make sure A/D Int not set
        ADCON0bits.GO=1;                    //and begin A/D conv.
        while(!PIR1bits.ADIF);              //Wait for A/D convert complete

        Vread = ADRES;                      //Get the value from the A/D
        PIR1bits.ADIF = 0;                  //Clear A/D Interrupt Flag
        VTot += Vread;                      //Add the reading to the total
    }

    Vavg = (float)(VTot/10.000);            //Average of 10 readings
    Vcal = (float)(Vavg/ADSCALE*ADREF);
    CTMUISrc = Vcal/RCAL;                   //CTMUISrc is in 1/100ths of uA

}
```


REGISTER 22-2: VREFCON2: VOLTAGE REFERENCE CONTROL REGISTER 1

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	—	DACR<4:0>				
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4-0 **DACR<4:0>:** DAC Voltage Output Select bits
$V_{OUT} = ((V_{SRC+}) - (V_{SRC-}))*(DACR<4:0>/(2^5)) + V_{SRC-}$

TABLE 22-1: REGISTERS ASSOCIATED WITH DAC MODULE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
VREFCON0	FVREN	FVRST	FVRS<1:0>		—	—	—	—	332
VREFCON1	DACEN	DACLPS	DACOE	—	DACPSS<1:0>		—	DACNSS	335
VREFCON2	—	—	—	DACR<4:0>					336

Legend: — = Unimplemented locations, read as ‘0’. Shaded bits are not used by the DAC module.

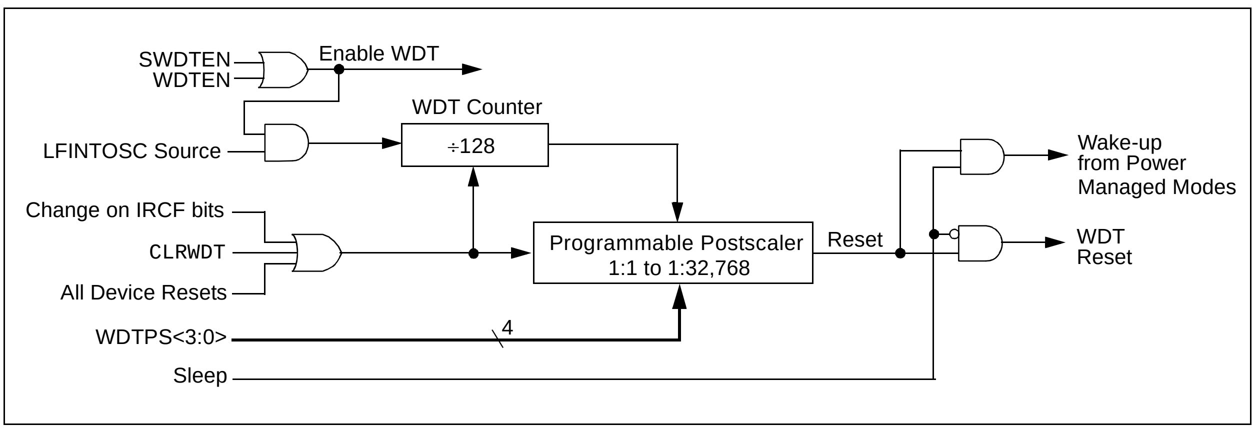
24.3 Watchdog Timer (WDT)

For PIC18(L)F2X/4XK22 devices, the WDT is driven by the LFINTOSC source. When the WDT is enabled, the clock source is also enabled. The nominal WDT period is 4 ms and has the same stability as the LFINTOSC oscillator.

The 4 ms period of the WDT is multiplied by a 16-bit postscaler. Any output of the WDT postscaler is selected by a multiplexer, controlled by bits in Configuration Register 2H. Available periods range from 4 ms to 131.072 seconds (2.18 minutes). The WDT and postscaler are cleared when any of the following events occur: a `SLEEP` or `CLRWDT` instruction is executed, the IRCF bits of the OSCCON register are changed or a clock failure has occurred.

> **Note 1:** The `CLRWDT` and `SLEEP` instructions clear the WDT and postscaler counts when executed.
>
> **2:** Changing the setting of the IRCF bits of the OSCCON register clears the WDT and postscaler counts.
>
> **3:** When a `CLRWDT` instruction is executed, the postscaler count will be cleared.

FIGURE 24-1: WDT BLOCK DIAGRAM



25.2 Extended Instruction Set

In addition to the standard 75 instructions of the PIC18 instruction set, PIC18(L)F2X/4XK22 devices also provide an optional extension to the core CPU functionality. The added features include eight additional instructions that augment indirect and indexed addressing operations and the implementation of Indexed Literal Offset Addressing mode for many of the standard PIC18 instructions.

The additional features of the extended instruction set are disabled by default. To enable them, users must set the XINST Configuration bit.

The instructions in the extended set can all be classified as literal operations, which either manipulate the File Select Registers, or use them for indexed addressing. Two of the instructions, `ADDFSR` and `SUBFSR`, each have an additional special instantiation for using FSR2. These versions (`ADDULNK` and `SUBULNK`) allow for automatic return after execution.

The extended instructions are specifically implemented to optimize re-entrant program code (that is, code that is recursive or that uses a software stack) written in high-level languages, particularly C. Among other things, they allow users working in high-level languages to perform certain operations on data structures more efficiently. These include:

- dynamic allocation and deallocation of software stack space when entering and leaving subroutines
- function pointer invocation
- software Stack Pointer manipulation
- manipulation of variables located in a software stack

A summary of the instructions in the extended instruction set is provided in Table 25-3. Detailed descriptions are provided in **Section 25.2.2 "Extended Instruction Set"**. The opcode field descriptions in Table 25-1 apply to both the standard and extended PIC18 instruction sets.

> **Note:** The instruction set extension and the Indexed Literal Offset Addressing mode were designed for optimizing applications written in C; the user may likely never use these instructions directly in assembler. The syntax for these commands is provided as a reference for users who may be reviewing code that has been generated by a compiler.

25.2.1 EXTENDED INSTRUCTION SYNTAX

Most of the extended instructions use indexed arguments, using one of the File Select Registers and some offset to specify a source or destination register. When an argument for an instruction serves as part of indexed addressing, it is enclosed in square brackets ("[ ]"). This is done to indicate that the argument is used as an index or offset. MPASM™ Assembler will flag an error if it determines that an index or offset value is not bracketed.

When the extended instruction set is enabled, brackets are also used to indicate index arguments in byte-oriented and bit-oriented instructions. This is in addition to other changes in their syntax. For more details, see **Section 25.2.3.1 "Extended Instruction Syntax with Standard PIC18 Commands"**.

> **Note:** In the past, square brackets have been used to denote optional arguments in the PIC18 and earlier instruction sets. In this text and going forward, optional arguments are denoted by braces ("{ }").

TABLE 25-3: EXTENSIONS TO THE PIC18 INSTRUCTION SET

Mnemonic,	Operands	Description		Cycles	16-Bit Instruction Word				Status Affected
					MSb			LSb	
ADDFSR	f, k	Add literal to FSR		1	1110	1000	ffkk	kkkk	None
ADDULNK	k	Add literal to FSR2 and return		2	1110	1000	11kk	kkkk	None
CALLW		Call subroutine using WREG		2	0000	0000	0001	0100	None
MOVSF	z_s, f_d	Move z_s (source) to	1st word	2	1110	1011	0zzz	zzzz	None
		f_d (destination)	2nd word		1111	ffff	ffff	ffff	
MOVSS	z_s, z_d	Move z_s (source) to	1st word	2	1110	1011	1zzz	zzzz	None
		z_d (destination)	2nd word		1111	xxxx	xzzz	zzzz	
PUSHL	k	Store literal at FSR2, decrement FSR2		1	1110	1010	kkkk	kkkk	None
SUBFSR	f, k	Subtract literal from FSR		1	1110	1001	ffkk	kkkk	None
SUBULNK	k	Subtract literal from FSR2 and return		2	1110	1001	11kk	kkkk	None

TABLE 27-18: MASTER SSP I^{2}C BUS DATA REQUIREMENTS

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
100	THIGH	Clock High Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
101	TLOW	Clock Low Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
102	TR	SDA and SCL Rise Time	100 kHz mode	—	1000	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode(1)	—	300	ns	
103	TF	SDA and SCL Fall Time	100 kHz mode	—	300	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode(1)	—	100	ns	
90	TSU:STA	Start Condition Setup Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	Only relevant for Repeated Start condition
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
91	THD:STA	Start Condition Hold Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	After this period, the first clock pulse is generated
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
106	THD:DAT	Data Input Hold Time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	ms	
107	TSU:DAT	Data Input Setup Time	100 kHz mode	250	—	ns	**(Note 2)**
			400 kHz mode	100	—	ns	
92	TSU:STO	Stop Condition Setup Time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
109	TAA	Output Valid from Clock	100 kHz mode	—	3500	ns	
			400 kHz mode	—	1000	ns	
			1 MHz mode(1)	—	—	ns	
110	TBUF	Bus Free Time	100 kHz mode	4.7	—	ms	Time the bus must be free before a new trans-mission can start
			400 kHz mode	1.3	—	ms	
D102	CB	Bus Capacitive Loading		—	400	pF	

Note 1: Maximum pin capacitance = 10 pF for all I^{2}C pins.

2: A fast mode I^{2}C bus device can be used in a standard mode I^{2}C bus system, but parameter 107 ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the Low period of the SCL signal. If such a device does stretch the Low period of the SCL signal, it must output the next data bit to the SDA line, parameter 102 + parameter 107 = 1000 + 250 = 1250 ns (for 100 kHz mode), before the SCL line is released.

FIGURE 28-20: PIC18LF2X/4XK22 TYPICAL IDD: RC_RUN LF-INTOSC 31 kHz

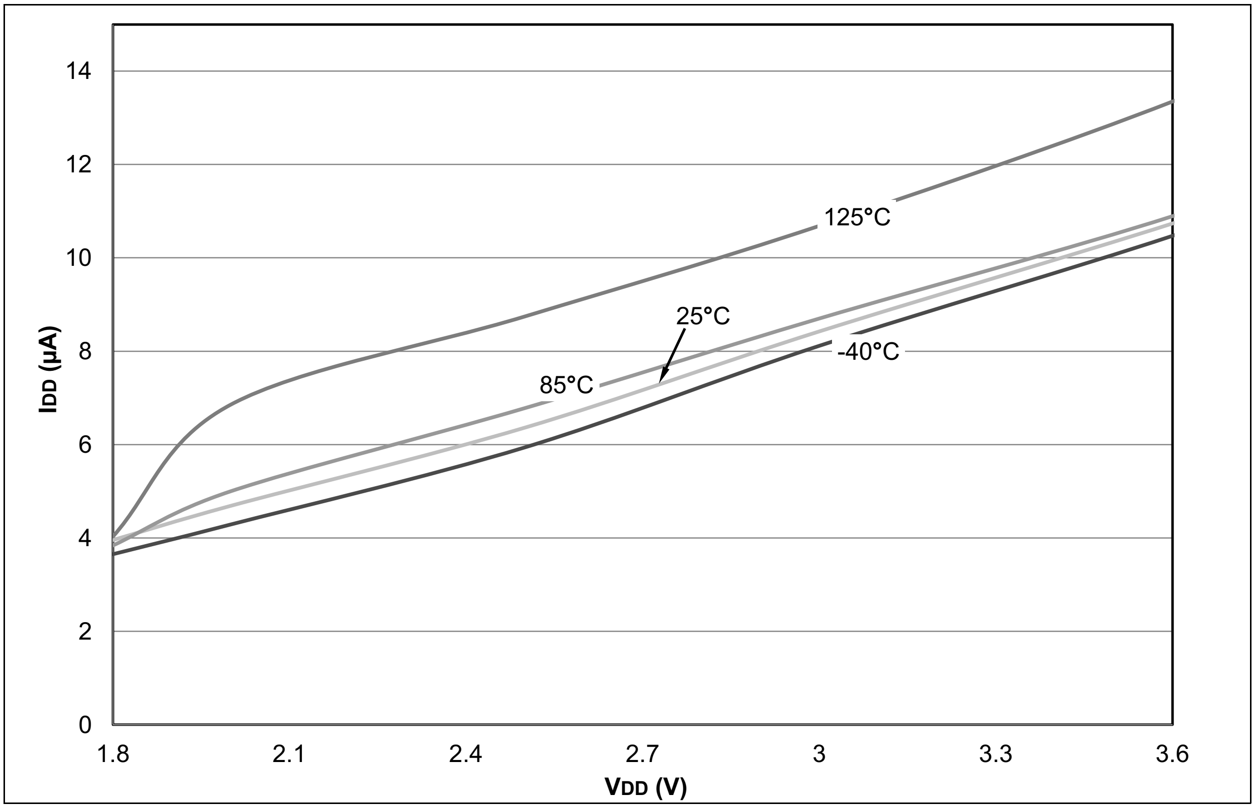


FIGURE 28-21: PIC18LF2X/4XK22 MAXIMUM IDD: RC_RUN LF-INTOSC 31 kHz

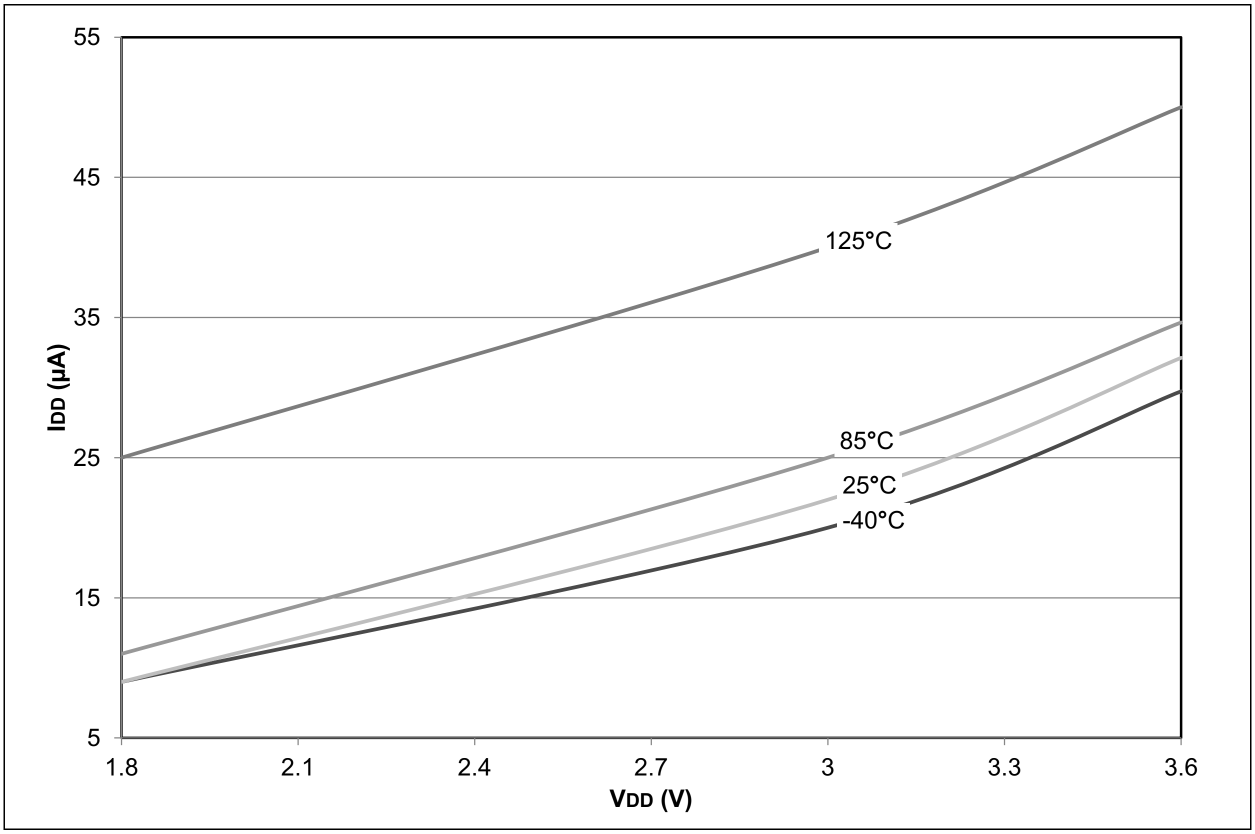


FIGURE 28-38: PIC18LF2X/4XK22 IDD: RC_IDLE MF-INTOSC 500 kHz

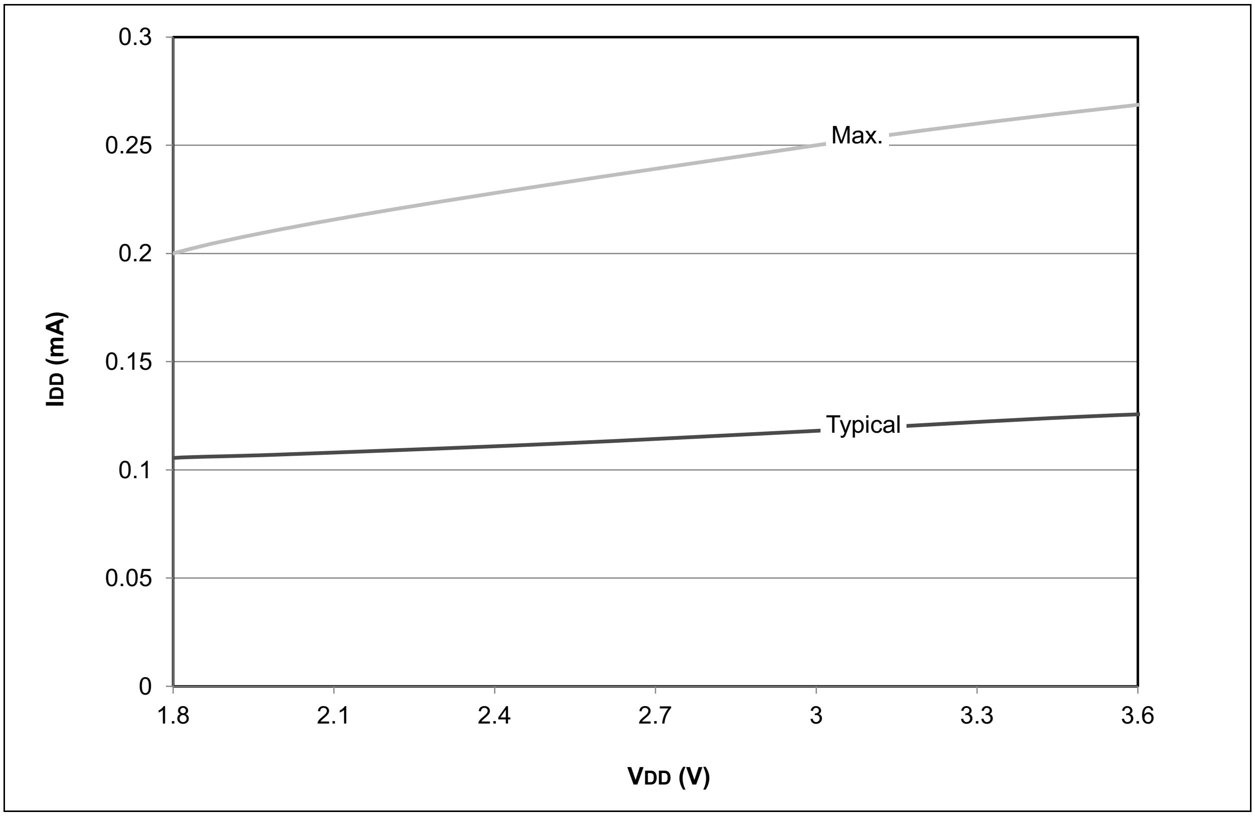


FIGURE 28-39: PIC18F2X/4XK22 IDD: RC_IDLE MF-INTOSC 500 kHz

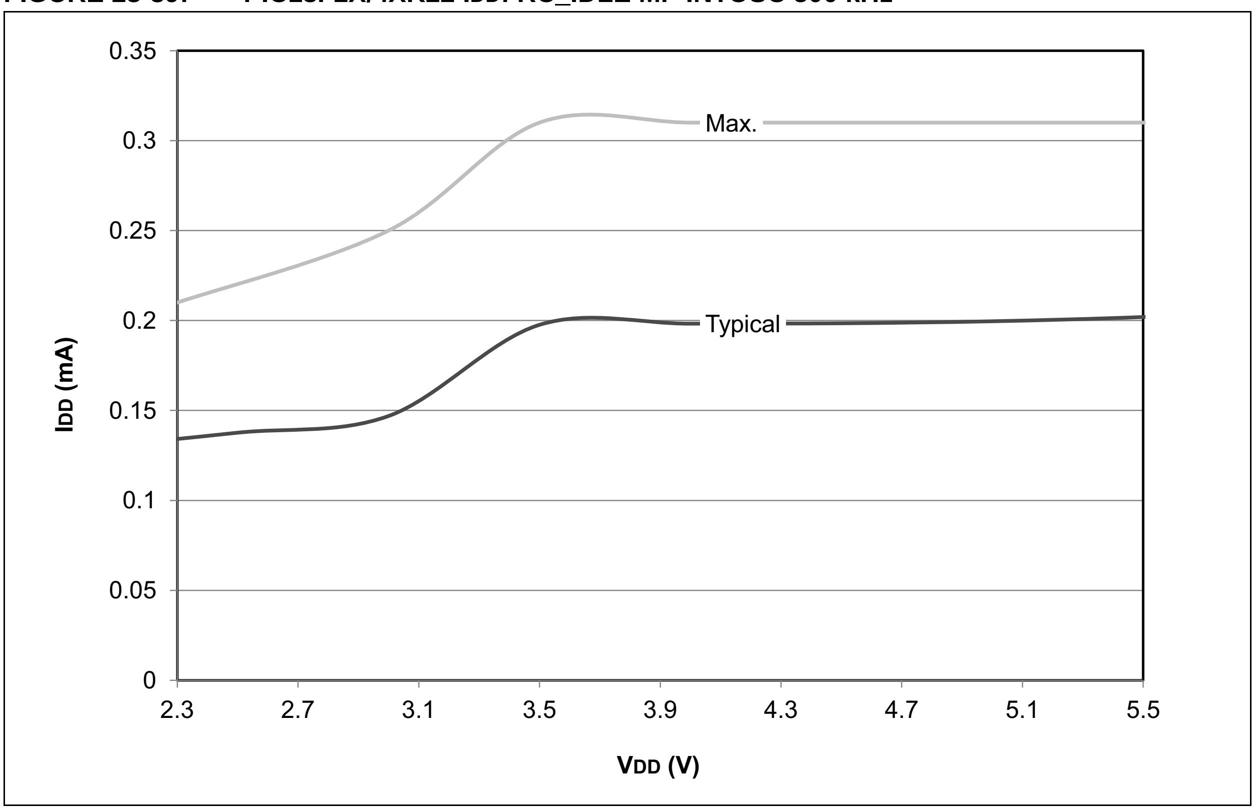


FIGURE 28-44: PIC18LF2X/4XK22 TYPICAL IDD: RC_IDLE HF-INTOSC with PLL

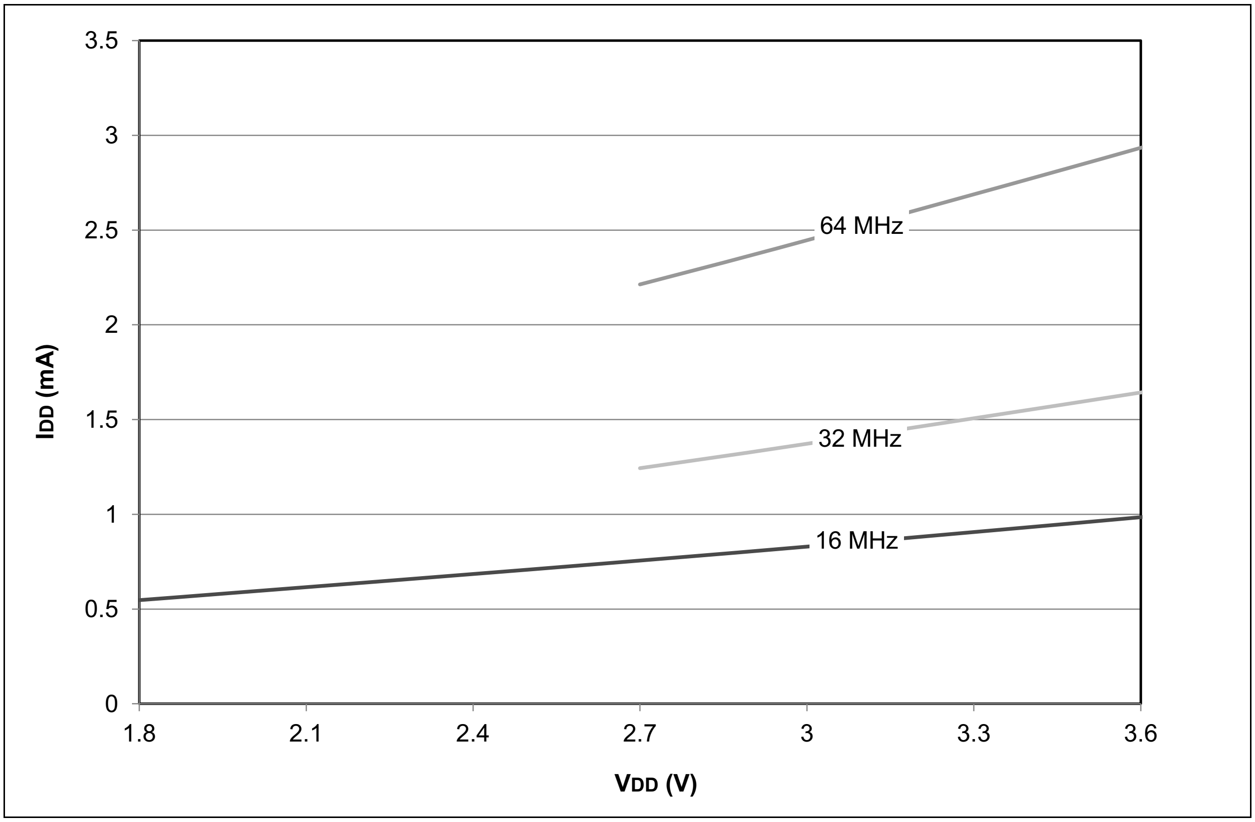


FIGURE 28-45: PIC18LF2X/4XK22 MAXIMUM IDD: RC_IDLE HF-INTOSC with PLL

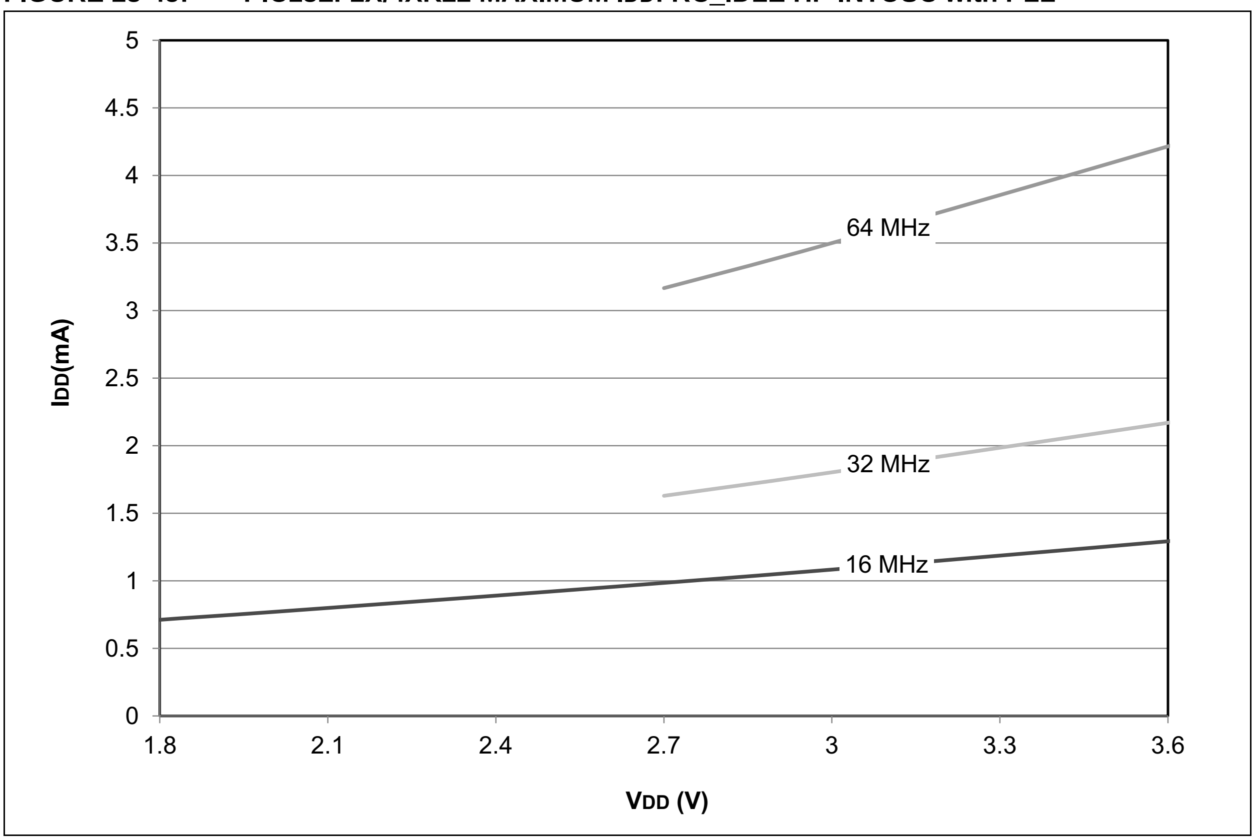


FIGURE 28-46: PIC18F2X/4XK22 TYPICAL I_{DD}: RC_IDLE HF-INTOSC with PLL

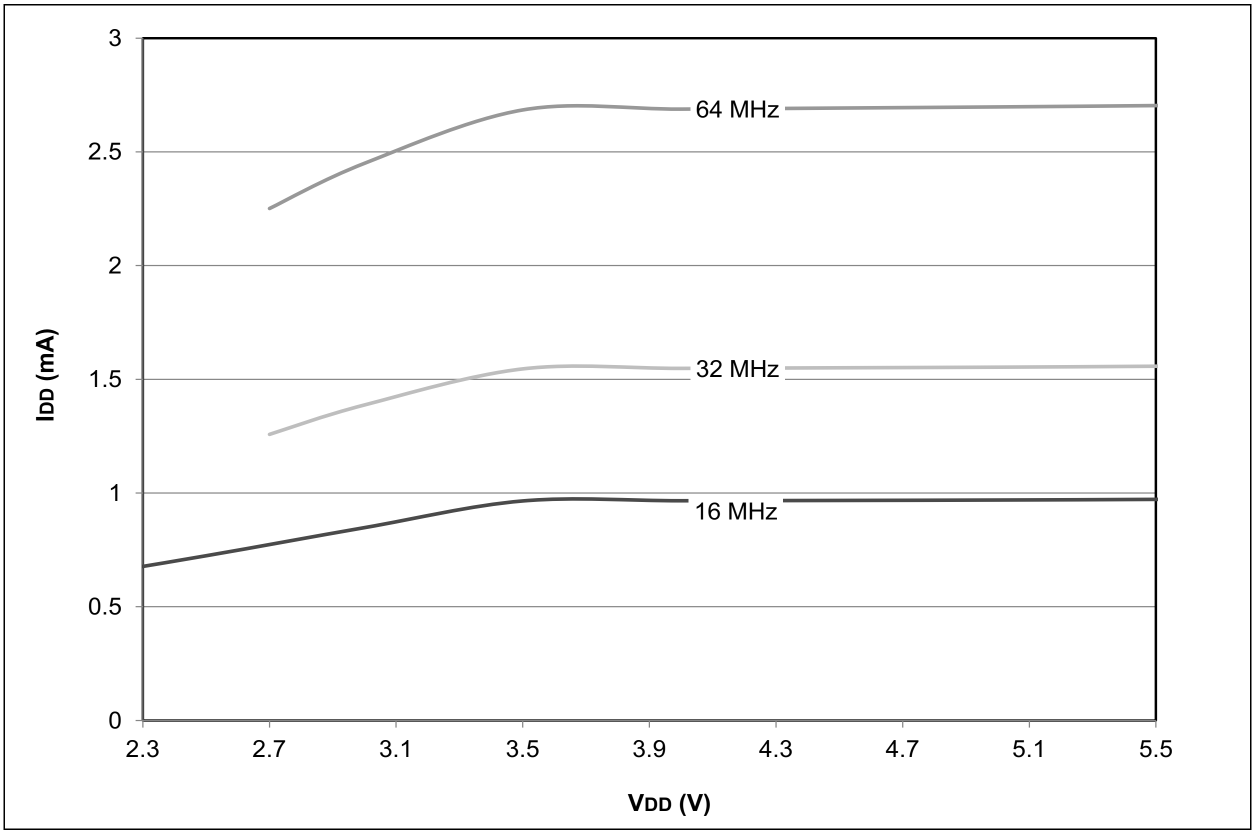


FIGURE 28-47: PIC18F2X/4XK22 MAXIMUM I_{DD}: RC_IDLE HF-INTOSC with PLL

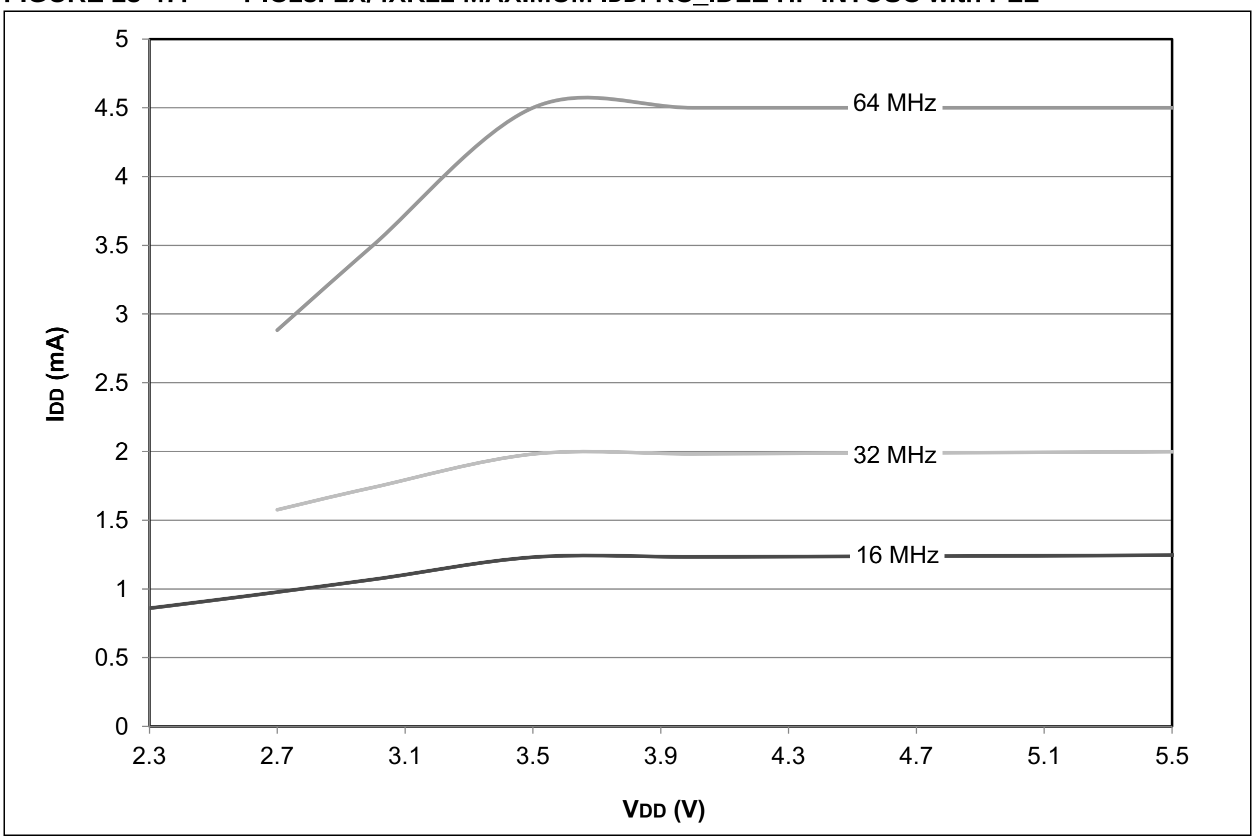


FIGURE 28-94: PIC18(L)F2X/4XK22 TYPICAL FIXED VOLTAGE REFERENCE 1x OUTPUT

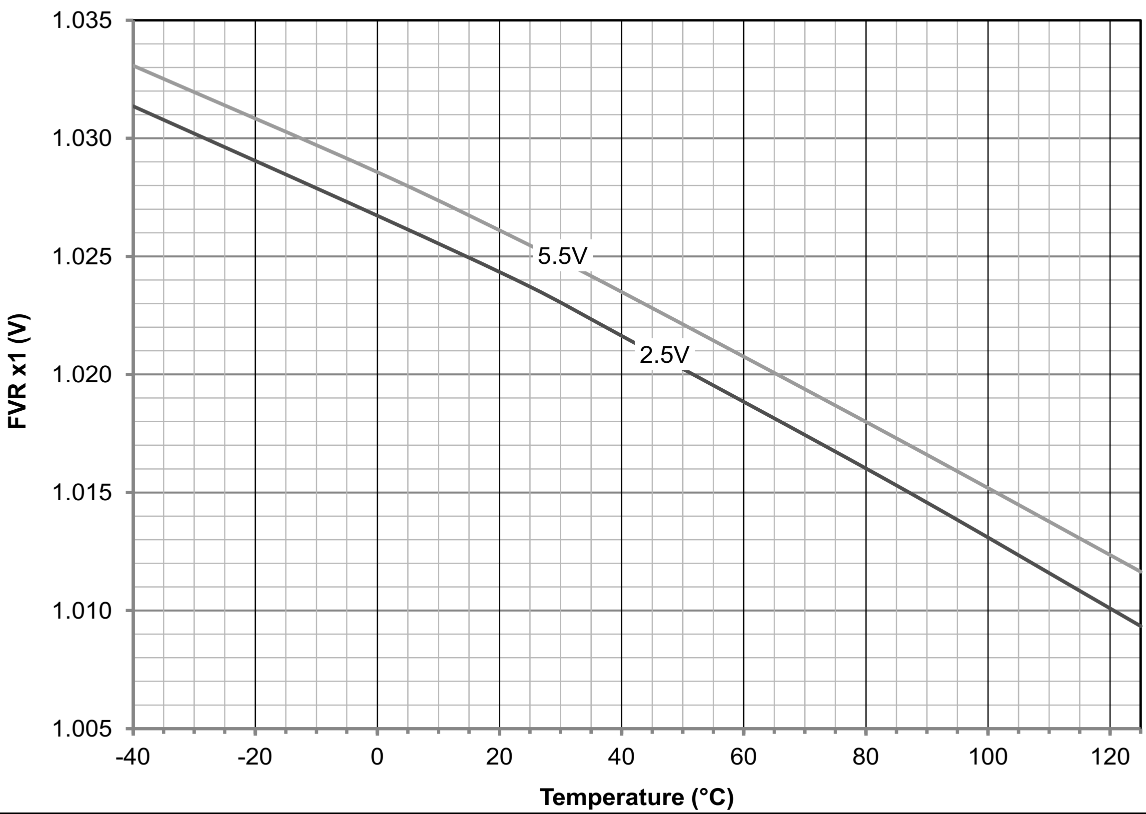
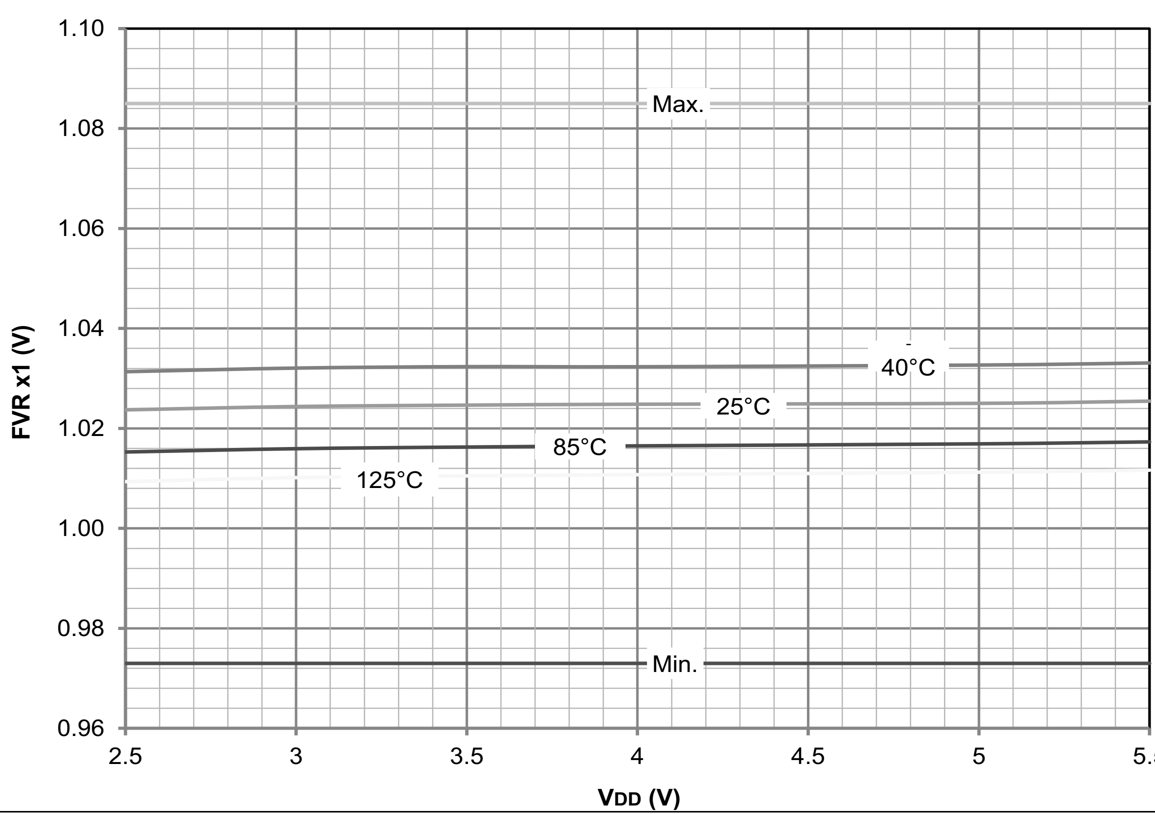
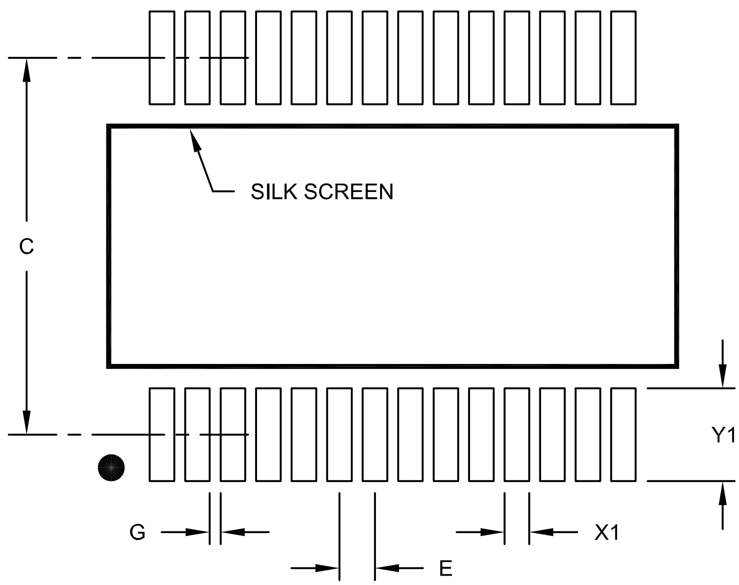


FIGURE 28-95: PIC18(L)F2X/4XK22 TYPICAL FIXED VOLTAGE REFERENCE 1x OUTPUT



28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Contact Pad Spacing	C		7.20	
Contact Pad Width (X28)	X1			0.45
Contact Pad Length (X28)	Y1			1.75
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2073A

